



Product Change Notification

Change Notification #: 116289 - 00
Change Title: Intel® Storage System JBOD2312S3SP PCN 116289-00, Label, Power supply logo change
Date of Publication: June 04, 2018

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

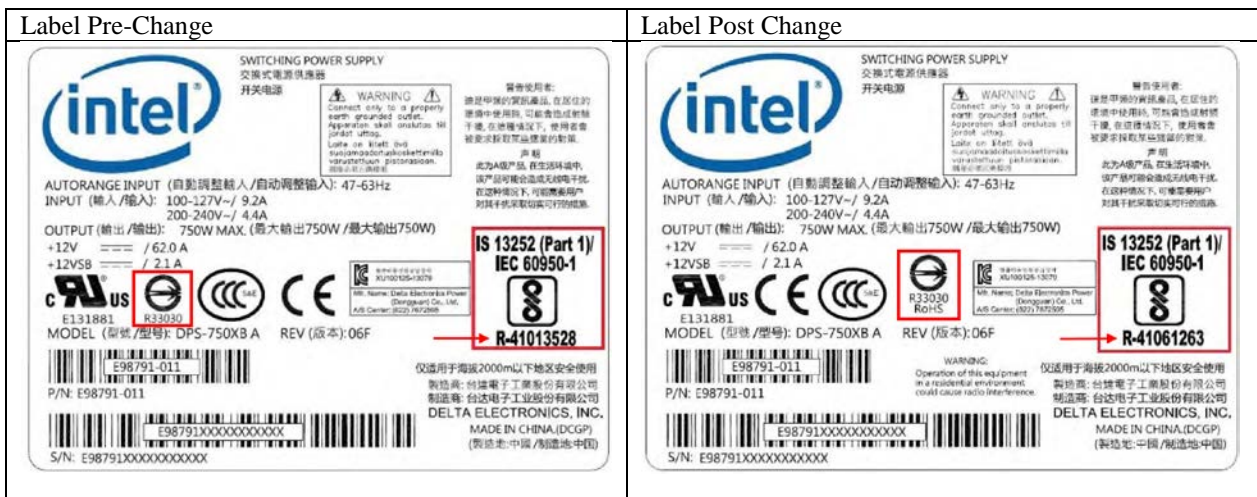
Date Customer Must be Ready to Receive Post-Conversion Material: *	June 18, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following change on the Intel® Storage System JBOD2312S3SP power supply label change.

1. Change BIS safety mark from R-41013528 to R-41061263 on the spec label.
2. The BSMI safety mark is being added "RoHS".



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from this change. Customers may need to validate the function and feature change once the post-change system is available.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
JBOD2312S3SP	939205	H54802-006	H54802-007

PCN Revision History:

Date of Revision:

June 4, 2018

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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